



1-17-02

AJI

Atty. Docket No. AMAT/5908/CPI/AL/WIRE/PJS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box Patent Application
Assistant Commissioner of Patents and Trademarks
Washington, D.C. 20231

JC971 U.S. PTO
10/04/954
01/14/02

Re: Inventor(s): HOUGONG WANG; KENNY KING-TAI NGAN and ZHENG XU
Title: SEMICONDUCTOR WAFER PREHEATING

Transmitted herewith is the patent application identified above, including:

- Specification, claims and abstract, totaling 27 pages.
 Drawings totaling 5 pages, Formal Informal.
 Executed Declaration and Power of Attorney.
 Information Disclosure Statement w/ Form 1449 and References.
 Assignment of the invention to **Applied Materials, Inc.**
 Assignment Recordation Cover Sheet

FEE CALCULATION					
Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total
Total Claims	64	-20=	44	x \$18.00	-\$792.00
Independent Claims	4	-3=	1	x \$84.00	-\$ 84.00
				\$740.00	\$ 740.00
TOTAL FEES					\$1,616.00

- The Commissioner is hereby authorized to charge \$1,616.00 to Deposit Account No. 50-1074/5908/CPI/AL WIRE/PJS.
 The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 50-1074/5908/CPI/AL WIRE/PJS. A duplicate copy of this transmittal is enclosed.
 Please address all future correspondence to:

**PATENT COUNSEL
APPLIED MATERIALS, INC.
Legal Affairs Department
P.O.BOX 450A
Santa Clara, CA. 95052**

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231.

Express Mail Receipt No. EL849164562US

Date of Deposit 1-14-02

Signature Robert W. Mulcahy

Respectfully submitted,

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